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Our File No.: SPLX.P0081

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Mani Adeli

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 10-30-03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application for:

Steven Teig

Examiner: <not assigned yet>

Serial No.: 10/076,121

Filing Date: 2/12/02

For: METHOD AND APPARATUS FOR  
GENERATING MULTI-LAYER  
ROUTES

RECEIVED  
MAY 29 2003  
TC 2800 MAIL ROOM

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Please amend the application as follows:

**IN THE SPECIFICATION**

Please delete the ~~"Claim of Benefit to Provisional Application"~~ on page 1, lines 2-9, and insert therein a new "Claim of Benefit to Prior Applications" as follows:

**--CLAIM OF BENEFIT TO PROVISIONAL APPLICATION**

This patent application claims the benefit of the earlier-field U.S. Provisional Patent Application entitled "Interconnect Method, Apparatus, and Architecture for Integrated Circuits and Integrated-Circuit Layouts", having serial number 60/295,735, and filed 6/3/2001; and U.S. Provisional Patent Application entitled "Interconnect Method, Apparatus, and Architecture for Integrated Circuits and Integrated-Circuit Layouts", having serial number 60/298,146, and filed

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